Octal Transparent Latch with 3-State Outputs; Octal D-Type Flip-Flop with 3-State Output

The SN74LS373 consists of eight latches with 3-state outputs for bus organized system applications. The flip-flops appear transparent to the data (data changes asynchronously) when Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup times is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH the bus output is in the high impedance state.

The SN74LS374 is a high-speed, low-power Octal D-type Flip-Flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus oriented applications. A buffered Clock (CP) and Output Enable (OE) is common to all flip-flops. The SN74LS374 is manufactured using advanced Low Power Schottky technology and is compatible with all ON Semiconductor TTL families.

- Eight Latches in a Single Package
- 3-State Outputs for Bus Interfacing
- Hysteresis on Latch Enable
- Edge-Triggered D-Type Inputs
- Buffered Positive Edge-Triggered Clock
- Hysteresis on Clock Input to Improve Noise Margin
- Input Clamp Diodes Limit High Speed Termination Effects

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-2.6	mA
I _{OL}	Output Current – Low			24	mA



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> LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 738

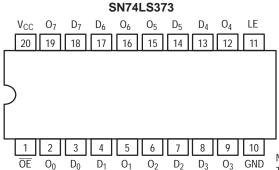


SOIC DW SUFFIX CASE 751D

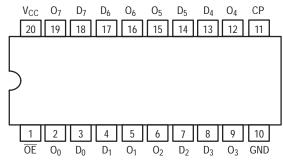
ORDERING INFORMATION

Device	Package	Shipping
SN74LS373N	16 Pin DIP	1440 Units/Box
SN74LS373DW	16 Pin	2500/Tape & Reel
SN74LS374N	16 Pin DIP	1440 Units/Box
SN74LS374DW	16 Pin	2500/Tape & Reel

CONNECTION DIAGRAM DIP (TOP VIEW)



SN74LS374



NOTE:

The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.

PIN NAMES

$D_0 - D_7$	Data inputs
LE	Latch Enable (Active HIGH) Input
CP	Clock (Active HIGH Going Edge) Input
<u>OE</u>	Output Enable (Active LOW) Input
$O_0 - O_7$	Outputs

Data Issuela

NOTES:

a) 1 TTL Unit Load (U.L.) = $40 \mu A HIGH/1.6 mA LOW$.

LOADING (Note a)

HIGH	LOW
0.5 U.L.	0.25 U.L.
65 U.L.	15 U.L.

TRUTH TABLE

LS373

D _n	LE	OE	On
Η	Η	L	Н
L	Н	L	L
Х	L	L	Q_0
Х	Х	Н	Z*

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance

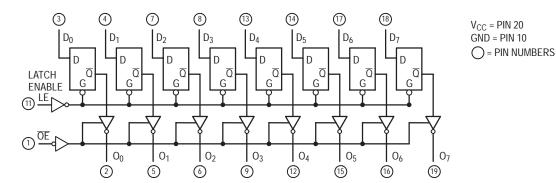
LS374

D _n	LE	ŌĒ	On
Н	4	L	Н
L	4	L	L
Х	Х	Н	Z*

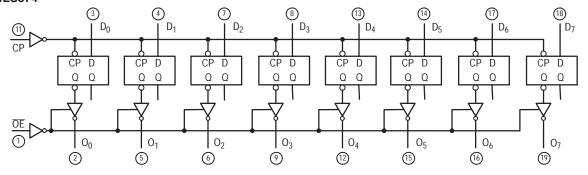
^{*} Note: Contents of flip-flops unaffected by the state of the Output Enable input (\overline{OE}) .

LOGIC DIAGRAMS

SN74LS373



SN74LS374



DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
V _{IH}	Input HIGH Voltage	2.0			V	Guaranteed Inpu	t HIGH Voltage for
V _{IL}	Input LOW Voltage			0.8	V	Guaranteed Inpu	t LOW Voltage for
V _{IK}	Input Clamp Diode Voltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	–18 mA
V _{OH}	Output HIGH Voltage	2.4	3.1		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
V	Output LOW Valtage		0.25	0.4	٧	I _{OL} = 12 mA	$V_{CC} = V_{CC} MIN,$
V _{OL}	Output LOW Voltage		0.35	0.5	V	I _{OL} = 24 mA	$V_{IN} = V_{IL}$ or V_{IH} per Truth Table
I _{OZH}	Output Off Current HIGH			20	μΑ	$V_{CC} = MAX, V_{OU}$	_T = 2.7 V
I _{OZL}	Output Off Current LOW			-20	μΑ	V _{CC} = MAX, V _{OU}	T = 0.4 V
,	Input HICH Current			20	μΑ	$V_{CC} = MAX, V_{IN} = 2.7 V$	
l _{IH}	Input HIGH Current			0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
I _{IL}	Input LOW Current			-0.4	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
Ios	Short Circuit Current (Note 1)	-30		-130	mA	V _{CC} = MAX	
I _{CC}	Power Supply Current			40	mA	$V_{CC} = MAX$	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

			Limits						
			LS373		LS374		LS374		
Symbol	Parameter	Min	Тур	Max	Min	Тур	Max	Unit	Test Conditions
f _{MAX}	Maximum Clock Frequency				35	50		MHz	
t _{PLH} t _{PHL}	Propagation Delay, Data to Output		12 12	18 18				ns	C - 45 pE
t _{PLH} t _{PHL}	Clock or Enable to Output		20 18	30 30		15 19	28 28	ns	$C_L = 45 \text{ pF},$ $R_L = 667 \Omega$
t _{PZH} t _{PZL}	Output Enable Time		15 25	28 36		20 21	28 28	ns	
t _{PHZ} t _{PLZ}	Output Disable Time		12 15	20 25		12 15	20 25	ns	C _L = 5.0 pF

AC SETUP REQUIREMENTS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

		Limits				
		LS373		LS374		
Symbol	Parameter	Min	Max	Min	Max	Unit
t _W	Clock Pulse Width	15		15		ns
t _s	Setup Time	5.0		20		ns
t _h	Hold Time	20		0		ns

DEFINITION OF TERMS

SETUP TIME (t_s) — is defined as the minimum time required for the correct logic level to be present at the logic input prior to LE transition from HIGH-to-LOW in order to be recognized and transferred to the outputs.

HOLD TIME (t_h) — is defined as the minimum time following the LE transition from HIGH-to-LOW that the logic level must be maintained at the input in order to ensure continued recognition.

SN74LS373

AC WAVEFORMS

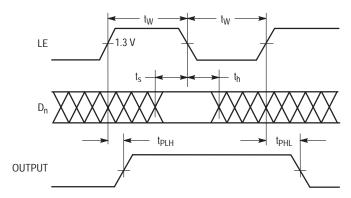


Figure 1.

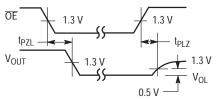


Figure 2.

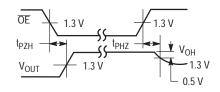


Figure 3.

AC LOAD CIRCUIT

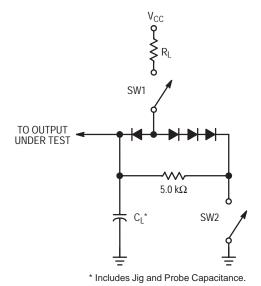


Figure 4.

SWITCH POSITIONS

SYMBOL	SW1	SW2
t _{PZH}	Open	Closed
t _{PZL}	Closed	Open
t _{PLZ}	Closed	Closed
t _{PH7}	Closed	Closed

SN74LS374

AC WAVEFORMS

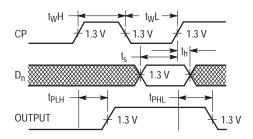
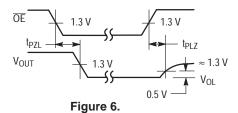


Figure 5.



0E 1.3 V 1.3 V 1.3 V V_{OUT} 1.3 V V_{OUT} 1.3 V V_{OUT} 0.5 V

Figure 7.

AC LOAD CIRCUIT

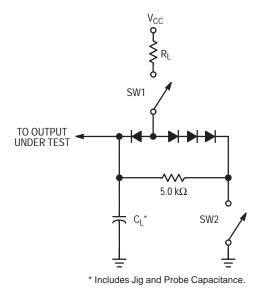


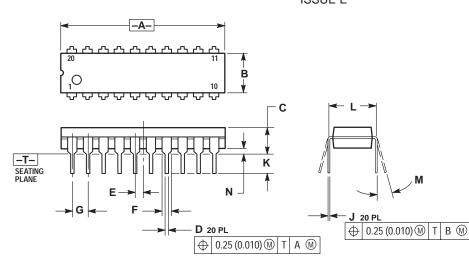
Figure 8.

SWITCH POSITIONS

SYMBOL	SW1	SW2
t _{PZH}	Open	Closed
t _{PZL}	Closed	Open
t _{PLZ}	Closed	Closed
t _{PH7}	Closed	Closed

PACKAGE DIMENSIONS

N SUFFIX PLASTIC PACKAGE CASE 738-03 **ISSUE E**

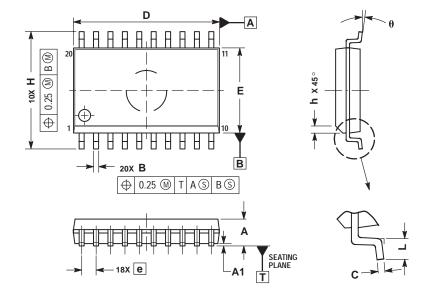


- IOLES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
 Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN

- FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.010	1.070	25.66	27.17	
В	0.240	0.260	6.10	6.60	
С	0.150	0.180	3.81	4.57	
D	0.015	0.022	0.39	0.55	
Ε	0.050	BSC	1.27 BSC		
F	0.050	0.070	1.27	1.77	
G	0.100	0.100 BSC		BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.140	2.80	3.55	
L	0.300	0.300 BSC		BSC	
M	0 °	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

D SUFFIX PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



- NOTES:

 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRICION.
- PROTRUSION.

 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS	
DIM	MIN	MAX
Α	2.35	2.65
A1	0.10	0.25
В	0.35	0.49
С	0.23	0.32
D	12.65	12.95
Ε	7.40	7.60
е	1.27 BSC	
Н	10.05	10.55
h	0.25	0.75
L	0.50	0.90
Δ	0.0	7.0

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